



# SMAK Plastic-Encapsulate Diodes

## Schottky Rectifier

### Features

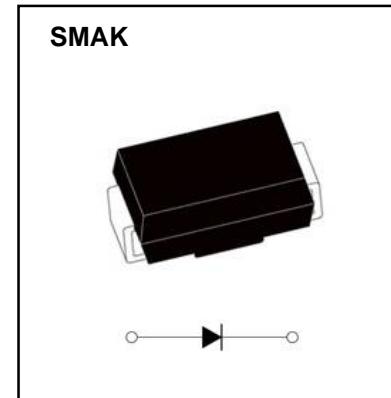
- $I_o$  3A
- $V_{RRM}$  40V
- High surge current capability
- Polarity: Color band denotes cathode
- Low  $V_f$

### Applications

- Rectifier

### Marking

- SS34L



### Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Conditions	SS34L
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		40
Maximum RMS Voltage	$V_{RMS}$	V		28
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave, Resistance load, $T_a=100^\circ C$	3.0
Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	60Hz Half-sine wave, 1 cycle, $T_a=25^\circ C$	120
Junction Temperature	$T_J$	°C		-55~+150
Storage Temperature	$T_{STG}$	°C		-55~+150

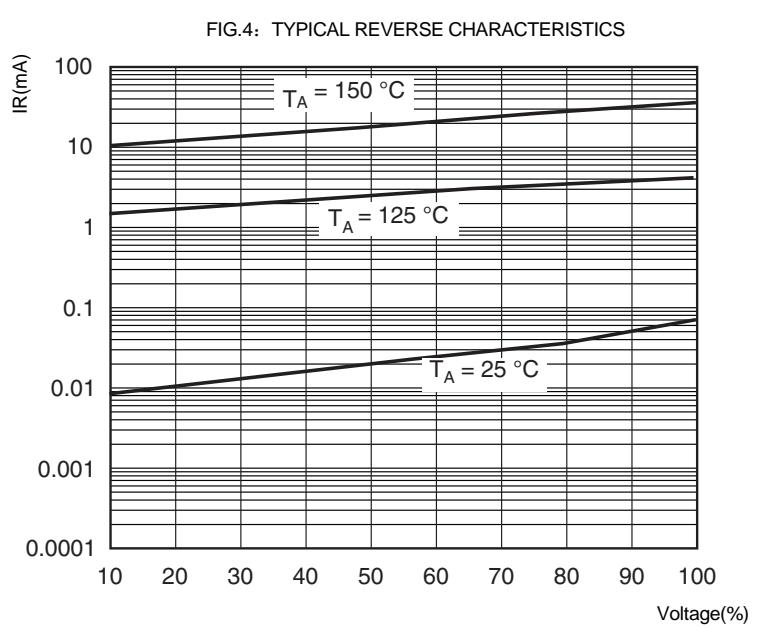
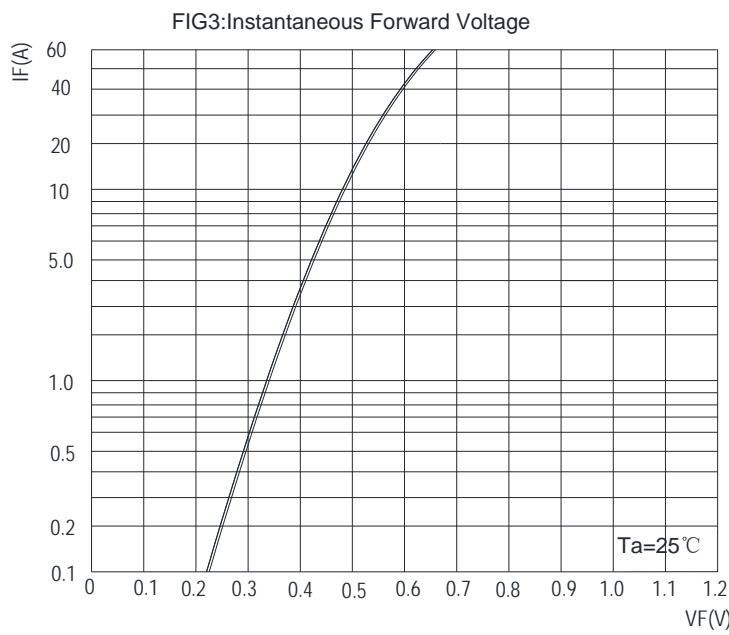
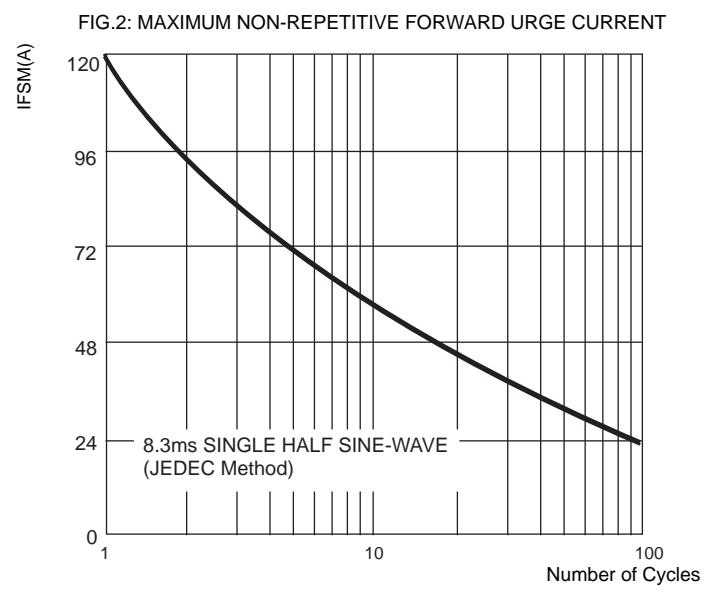
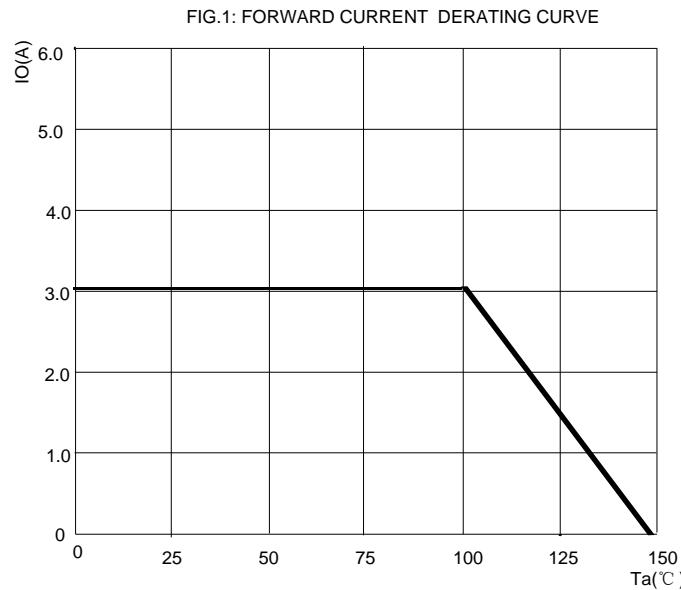
### Electrical Characteristics ( $T_a=25^\circ C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		SS34L
Peak Forward Voltage	$V_F$	V	$I_F=3A$	$T_a=25^\circ C$ $T_a=125^\circ C$	0.40 0.30
Peak Reverse Current	$I_{RRM1}$	mA	$V_{RM}=V_{RRM}$	$T_a=25^\circ C$	0.1
	$I_{RRM2}$			$T_a=125^\circ C$	20
Thermal Resistance(Typical)	$R_{\theta J-A}$	°C/W	Between junction and ambient		55
	$R_{\theta J-L}$		Between junction and lead		17

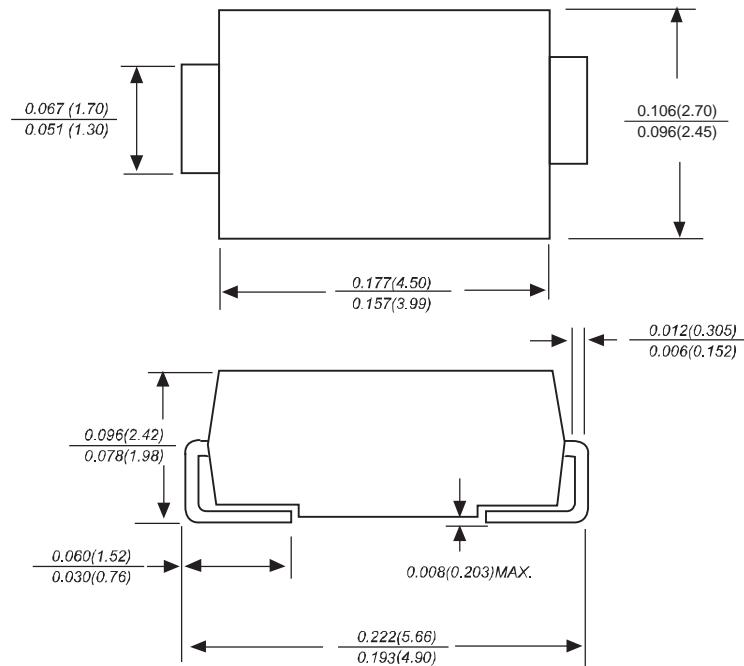
### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

## Typical Characteristics

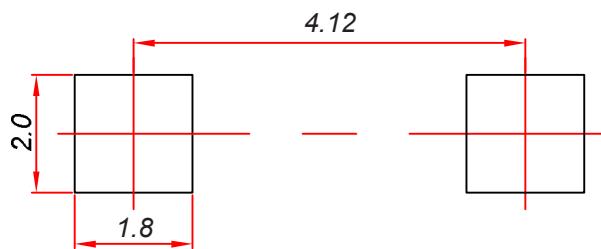


## SMAK Package Outline Dimensions



Dimensions in inches and (millimeters)

## SMAK Suggested Pad Layout



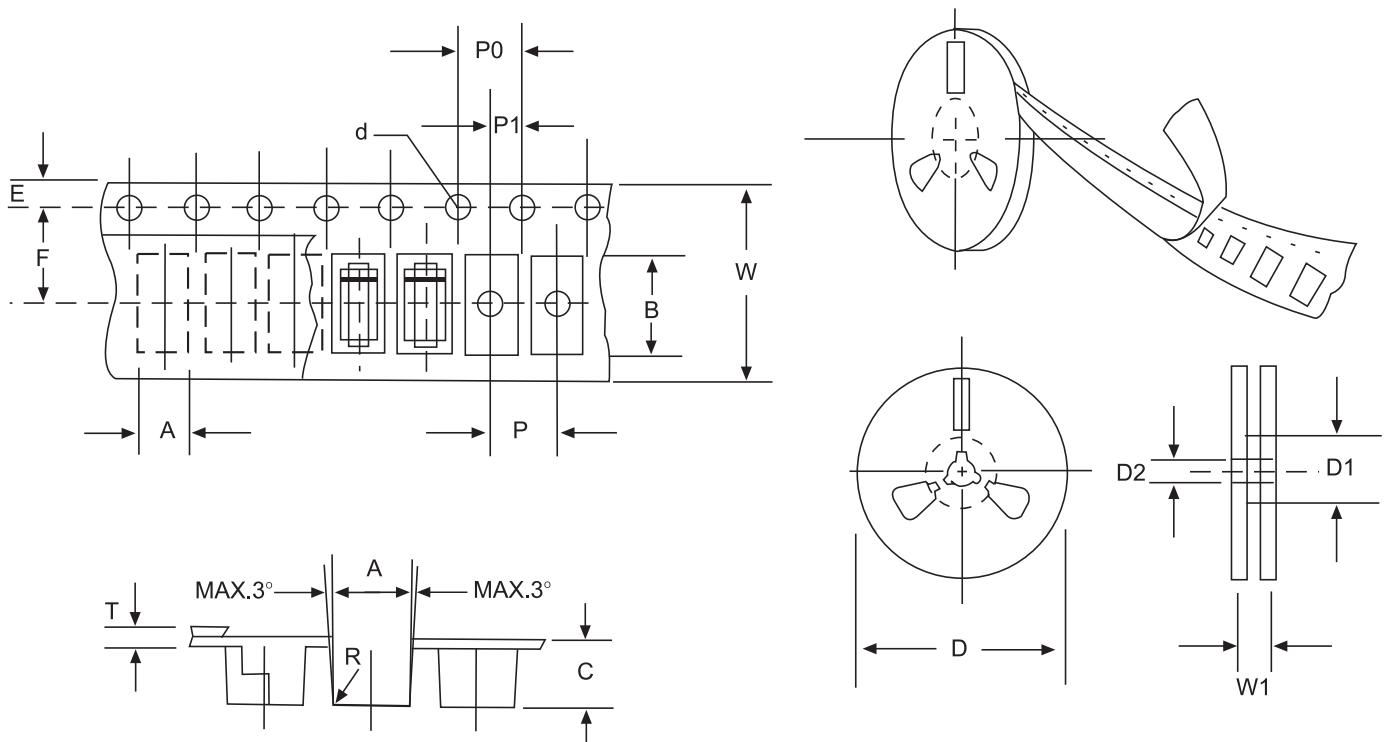
### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only.

### NOTICE

JSHD reserve the right to make modifications,enhancements, improvements, corrections or other changes without further notice to any product herein .JSHD does not assume any liability arising out of the application or use of any product described herein.

## Reel Taping Specifications For Surface Mount Devices-SMA



**FIG:CONFIGURATION OF AXIAL TAPING**

ITEM	SYMBOL	SMA mm(inch)
Carrier width	A	$2.79 \pm 0.1$ ( $0.110 \pm 0.004$ )
Carrier length	B	$5.33 \pm 0.1$ ( $0.210 \pm 0.004$ )
Carrier depth	C	$2.36 \pm 0.1$ ( $0.093 \pm 0.004$ )
Sprocket hole	d	$1.5 \pm 0.05$ ( $0.059 \pm 0.0002$ )
Reel outside diameter	D	$330/178 \pm 2.0$ ( $13/7.0 \pm 0.79$ )
Reel inner diameter	D1	$8.0 \pm 0.2$ ( $0.315 \pm 0.008$ )
Feed hole diameter	D2	$13 \pm 0.5$ ( $0.512 \pm 0.020$ )
Stroket hole position	E	$1.75 \pm 0.1$ ( $0.069 \pm 0.004$ )
Punch hole position	F	$5.5 \pm 0.05$ ( $0.217 \pm 0.002$ )
Punch hole pitch	P	$4.0 \pm 0.1$ ( $0.157 \pm 0.004$ )
Sprocket hole pitch	P0	$4.0 \pm 0.1$ ( $0.157 \pm 0.004$ )
Embossment center	P1	$2.0 \pm 0.1$ ( $0.079 \pm 0.004$ )
Total tape thickness	T	$0.28 \pm 0.02$ ( $0.011 \pm 0.0008$ )
Tape width	W	$12.0 \pm 0.2$ ( $0.472 \pm 0.008$ )
Reel width	W1	$16.8 \pm 2.0$ ( $0.661 \pm 0.079$ )

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.